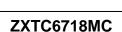




A Product Line of Diodes Incorporated



**COMPLEMENTARY 20V LOW SATURATION TRANSISTORS** 

#### Features

#### NPN Transistor

- $BV_{CEO} > 20V$ 
  - I<sub>C</sub> = 4.5A Continuous Collector Current
  - Low Saturation Voltage (150mV max @ 1A)
  - $R_{SAT} = 47m\Omega$  for a low equivalent On-Resistance

**PNP** Transistor

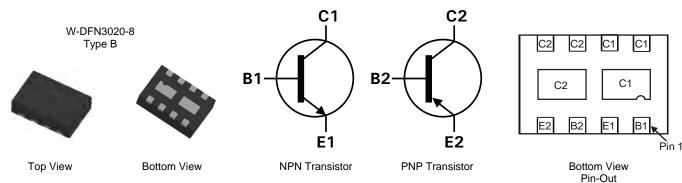
- $BV_{CEO} > -20V$ ٠
- I<sub>C</sub> = -3.5A Continuous Collector Current ٠
- Low Saturation Voltage (-220mV max @ -1A) .
- $R_{SAT} = 64m\Omega$  for a low equivalent On-Resistance
- hFF characterized up to 6A for high current gain hold up
- Low profile 0.8mm high package for thin applications
- R<sub>0JA</sub> efficient, 40% lower than SOT26
- 6mm<sup>2</sup> footprint, 50% smaller than TSOP6 and SOT26
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP capable (Note 4)

#### **Mechanical Data**

- Case: W-DFN3020-8 Type B
- Nominal package height: 0.8mm
- Case material: molded plastic. "Green" molding compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu, Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.013 grams (approximate)

#### Applications

- DC DC Converters
- Charging circuits
- Power switches
- Motor control
- LED Backlighting circuits
- Portable applications



#### Equivalent Circuit

### Ordering Information (Note 4 & 5)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTC6718MCTA	AEC-Q101	DB2	7	8	3,000
ZXTC6718MCQTA	Automotive	DB2	7	8	3,000

Notes:

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified.

5. For packaging details, go to our website at http://www.diodes.com

#### Marking Information



DB2 = Product type marking code Top view, dot denotes pin 1





## **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic		Symbol	NPN	PNP	Unit
Collector-Base Voltage		V <sub>CBO</sub>	40	-25	V
Collector-Emitter Voltage		V <sub>CEO</sub>	20	-20	V
Emitter-Base Voltage		V <sub>EBO</sub>	7	-7	V
Peak Pulse Current		I <sub>CM</sub>	12	-6	А
Continuous Collector Current (Notes 6 & 9)		Ι <sub>C</sub>	4.5	-3.5	A
Continuous Collector Current (Notes 7 & 9)			5	-3.8	
Base Current		IB		1	A

#### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

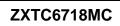
Characteristic	Symbol	NPN	PNP	Unit	
	(Notes 6 & 9)		1.5 12 2.45 19.6 1.13 8 1.7 13.6		₩ mW/°C
Power Dissipation	(Notes 7 & 9)	5			
Linear Derating Factor	(Notes 8 & 9)	PD			
	(Notes 8 & 10)	-			
	(Notes 6 & 9)		83.3 51.0		-
Thermal Registeres, Junction to Ambient	(Notes 7 & 9)	D D			
Thermal Resistance, Junction to Ambient	(Notes 8 & 9)	$R_{ extsf{ heta}JA}$	1	111	
	(Notes 8 & 10)	-	73.5		
Thermal Resistance, Junction to Lead (Notes 9 & 11)		$R_{ ext{ heta}JL}$	17.1		7
Operating and Storage Temperature Range	TJ, TSTG	-55 to	+150	°C	

Notes: 6. For a dual device surface mounted on 28mm x 28mm (8cm<sup>2</sup>) FR4 PCB with high coverage of single sided 2 oz copper, in still air conditions; the device is measured when operating in a steady-state condition. The heatsink is split in half with the exposed collector pads connected to each half.

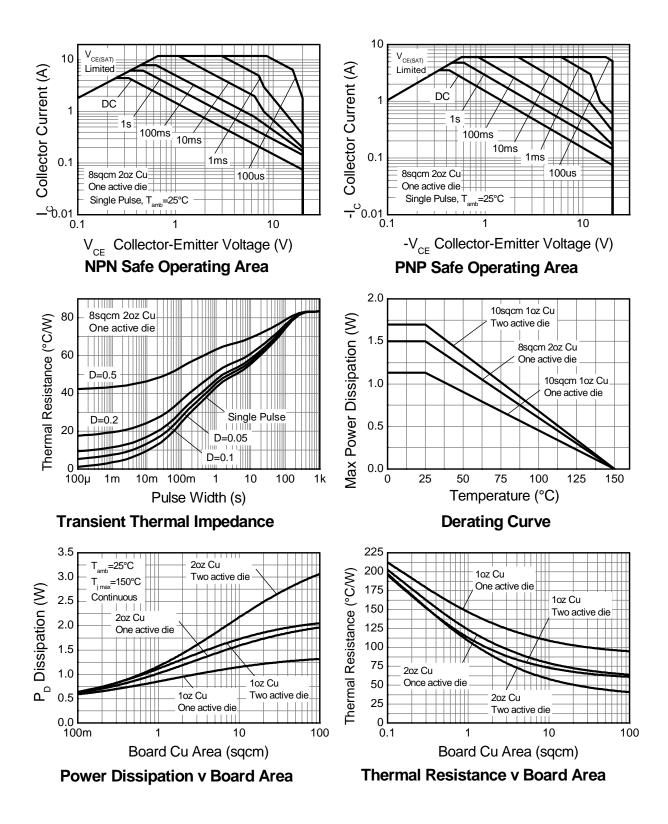
7. Same as note (6), except the device is surface mounted at t <5 sec.</li>
8. Same as note (6), except the device is surface mounted on 31mm x 31mm (10cm<sup>2</sup>) FR4 PCB with high coverage of single sided 1oz copper.
9. For a dual device with one active die.
10. For dual device with 2 active die running at equal power.

11. Thermal resistance from junction to solder-point (on the exposed collector pads).





## Thermal Characteristics and Derating Information





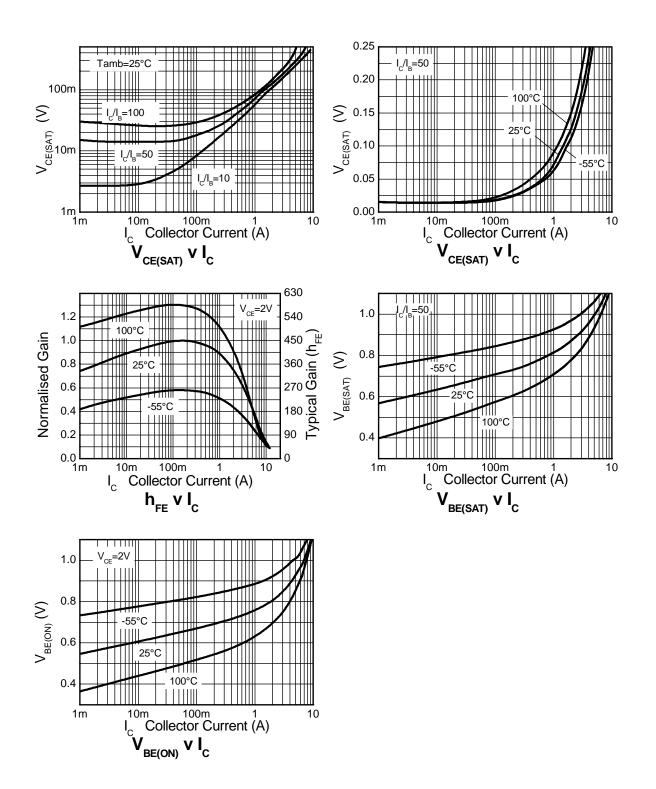
## **NPN - Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Ob any attacked to	O multiple	N.41	T	M	11	To al O an ilitian
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	40	100	-	V	I <sub>C</sub> = 100μA
Collector-Emitter Breakdown Voltage (Note 12)	BV <sub>CEO</sub>	20	27	-	V	$I_{C} = 10 \text{mA}$
Emitter-Base Breakdown Voltage	BVEBO	7	8.2	-	V	I <sub>E</sub> = 100μA
Collector Cutoff Current	I <sub>CBO</sub>	-	-	100	nA	$V_{CB} = 30V$
Emitter Cutoff Current	I <sub>EBO</sub>	-	-	100	. nA	$V_{EB} = 6V$
Collector Emitter Cutoff Current	ICES	-	-	100	nA	V <sub>CE</sub> = 16V
		200	400	-	-	$I_{C} = 10 \text{mA}, V_{CE} = 2 \text{V}$
Static Forward Current Transfer Ratio (Note 12)	h <sub>FE</sub>	300	450	-	-	$I_{C} = 200 \text{mA}, V_{CE} = 2 \text{V}$
	UFE	200	360	-	-	$I_{C} = 2A, V_{CE} = 2V$
		100	180	-	-	$I_{C} = 6A, V_{CE} = 2V$
			8	15	mV	$I_{C} = 0.1A, I_{B} = 10mA$
	V <sub>CE(sat)</sub>	-	90	150		$I_{C} = 1A, I_{B} = 10mA$
Collector-Emitter Saturation Voltage (Note 12)			115	135		$I_{\rm C} = 2A, I_{\rm B} = 50 \text{mA}$
			190	250		$I_{\rm C} = 3A, I_{\rm B} = 100 \text{mA}$
			210	300		$I_{\rm C} = 4.5 {\rm A}, I_{\rm B} = 125 {\rm mA}$
Base-Emitter Turn-On Voltage (Note 12)	V <sub>BE(on)</sub>	-	0.88	0.97	V	$I_{C} = 4.5A, V_{CE} = 2V$
Base-Emitter Saturation Voltage (Note 12)	V <sub>BE(sat)</sub>	-	0.98	1.07	V	$I_{C} = 4.5A, I_{B} = 125mA$
Output Capacitance	C <sub>obo</sub>	-	23	30	pF	V <sub>CB</sub> = 10V, f = 1MHz
Transition Frequency	f <sub>T</sub>	100	140	-	MHz	$V_{CE} = 10V$ , $I_C = 50mA$ , f = 100MHz
Turn-on Time	t <sub>on</sub>	-	170	-	ns	$V_{CC} = 10V, I_C = 3A$
Turn-off Time	t <sub>off</sub>	-	400	-	ns	$I_{B1} = I_{B2} = 10 \text{mA}$

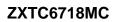
Notes: 12. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2%.



## **NPN - Typical Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)







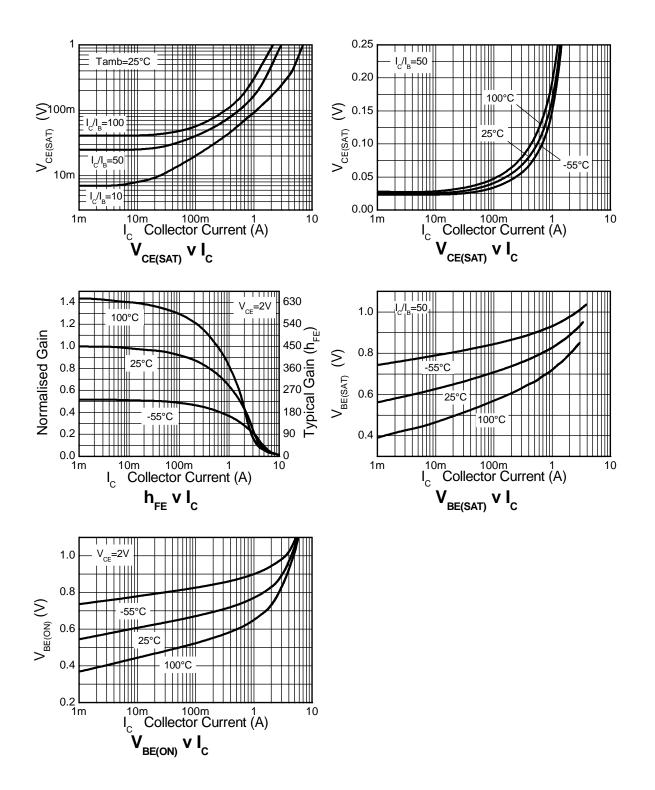
#### Characteristic Symbol Min Max Unit **Test Condition** Тур $I_{\rm C} = -100 \mu A$ Collector-Base Breakdown Voltage -25 -35 **BV**<sub>CBO</sub> ٧ Collector-Emitter Breakdown Voltage (Note 12) -20 -25 V $I_{C} = -10 mA$ $\mathsf{BV}_{\mathsf{CEO}}$ \_ Emitter-Base Breakdown Voltage **BV**<sub>EBO</sub> -7 -8.5 -V $I_{E} = -100 \mu A$ Collector Cutoff Current -100 $V_{CB} = -20V$ -Ісво nA -100 Emitter Cutoff Current \_ \_ nA $V_{EB} = -6V$ I<sub>EBO</sub> Collector Emitter Cutoff Current I<sub>CES</sub> -100 nA $V_{CES} = -16V$ $I_{C} = -10mA, V_{CE} = -2V$ 300 475 -300 450 $I_{C} = -100 \text{mA}, V_{CE} = -2 \text{V}$ -Static Forward Current Transfer Ratio (Note 12) h<sub>FE</sub> 150 230 - $I_{C} = -2A, V_{CE} = -2V$ 15 30 - $I_{C} = -6A, V_{CE} = -2V$ $I_{C} = -0.1A, I_{B} = -10mA$ -19 --30 $I_{C} = -1A, I_{B} = -20mA$ -220 -170 -Collector-Emitter Saturation Voltage (Note 12) --190 -250 m٧ $I_{C} = -1.5A, I_{B} = -50mA$ V<sub>CE(sat)</sub> -350 -240 - $I_{C} = -2.5A, I_{B} = -150mA$ --225 -300 I<sub>C</sub> = -3.5A, I<sub>B</sub> = -350mA Base-Emitter Turn-On Voltage (Note 12) -0.87 -0.95 V $I_C = -3.5A, V_{CE} = -2V$ V<sub>BE(on)</sub> -Base-Emitter Saturation Voltage (Note 12) -1.01 -1.12 V $I_{C} = -3.5A, I_{B} = -350mA$ V<sub>BE(sat)</sub> -Output Capacitance 21 30 V<sub>CB</sub> = -10V. f = 1MHz pF $C_{\text{obo}}$ - $V_{CE} = -10V, I_C = -50mA,$ Transition Frequency 180 -MHz 150 f<sub>T</sub> f = 100MHzTurn-on Time 40 ns $V_{CC} = -10V, I_C = -1A$ ton --Turn-off Time 670 $I_{B1} = I_{B2} = -10 \text{mA}$ toff -ns

#### PNP - Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Notes: 12. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2%.



## PNP - Typical Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)



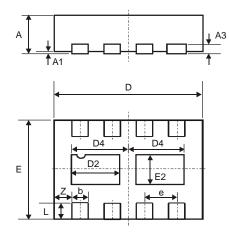




FX

## **Package Outline Dimensions**

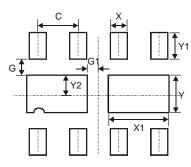
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



W-DFN3020-8						
Dim	Type B Dim Min Max Typ					
A	0.77	0.83	0.80			
A1	0	0.05	0.02			
A3	-	-	0.15			
b	0.25	0.35	0.30			
D	2.95	3.075	3.00			
D2	0.82	1.02	0.92			
D4	1.01	1.21	1.11			
е	-	-	0.65			
Е	1.95	2.075	2.00			
E2	0.43	0.63	0.53			
L	0.25	0.35	0.30			
Ζ	-	-	0.375			
All Dimensions in mm						

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
С	0.650			
G	0.285			
G1	0.090			
Х	0.400			
X1	1.120			
Y	0.730			
Y1	0.500			
Y2	0.365			



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